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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 14x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631bcdlj-u0

Table 1.4 Pin Functions (5/6)

Classifications	Pin Name	I/O	Description
Ethernet controller	ET_MDIO	I/O	Inputs or outputs bidirectional signals for exchange of management information between the RX63N Group and the PHY-LSI.
Parallel data capture unit (PDC)	PIXCLK	Input	Parallel data transfer clock
	VSYNC	Input	Vertical synchronization signal
	HSYNC	Input	Horizontal synchronization signal
	PIXD7 to PIXD0	Input	8-bit data
	PCKO	Output	Outputs parallel data transfer clock signal
USB power pins	VCC_USB	Input	Power supply pin. When the USB is not to be used, connect it to the VCC pin.
	VSS_USB	Input	Ground pin. When the USB is not to be used, connect it to the VSS pin.
USB 2.0 host/function module	USB0_DP, USB1_DP	I/O	Inputs or outputs USB transceiver D+ data.
	USB0_DM, USB1_DM	I/O	Inputs or outputs USB transceiver D- data.
	USB0_VBUS, USB1_VBUS	Input	Input pins for detection of connection and disconnection of the USB cable.
	USB0_EXICEN	Output	Output pin for control the low power of the OTG chip.
	USB0_VBUSEN	Output	Supply enable pin of VBUS (5 V) for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB,	Input	Input pin for detection of external over current.
	USB0_ID	Input	ID input pin of mini-AB connector at the OTG operation.
	USB0_DPUPE, USB1_DPUPE	Output	Pull-up control pins of the D+ signal at the function operation.
	USB0_DPRPD	Output	Pull-down control pins of the D+ signal at the host operation.
	USB0_DRPD	Output	Pull-down control pins of the D- signal at the host operation.
CAN module	CRX0 to CRX2	Input	Input pin.
	CTX0 to CTX2	Output	Output pin.
Serial peripheral interface	RSPCKA, RSPCKB, RSPCKC	I/O	Clock input/output pin.
	MOSIA, MOSIB, MOSIC	I/O	Inputs or outputs data output from the master.
	MISOA, MISOB, MISOC	I/O	Inputs or outputs data output from the slave.
	SSLA0, SSLB0, SSLC0	I/O	Input or output pins slave selection
	SSLA1 to SSLA3, SSLB1 to SSLB3, SSLC1 to SSLC3	Output	Output pins slave selection
	IEBus controller	IERXD	Input
IETXD		Output	Output pin for data transmission.
Realtime clock	RTCOUT	Output	Output pin for 1-Hz clock.
	RTCIC0 to RTCIC2	Input	Time capture event input pin
12-bit A/D converter	AN000 to AN020	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pins for the external trigger signals that start the A/D conversion.
10-bit A/D converter	AN0 to AN7	Input	Input pins for the analog signals to be processed by the A/D converter.
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
	ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion.
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.

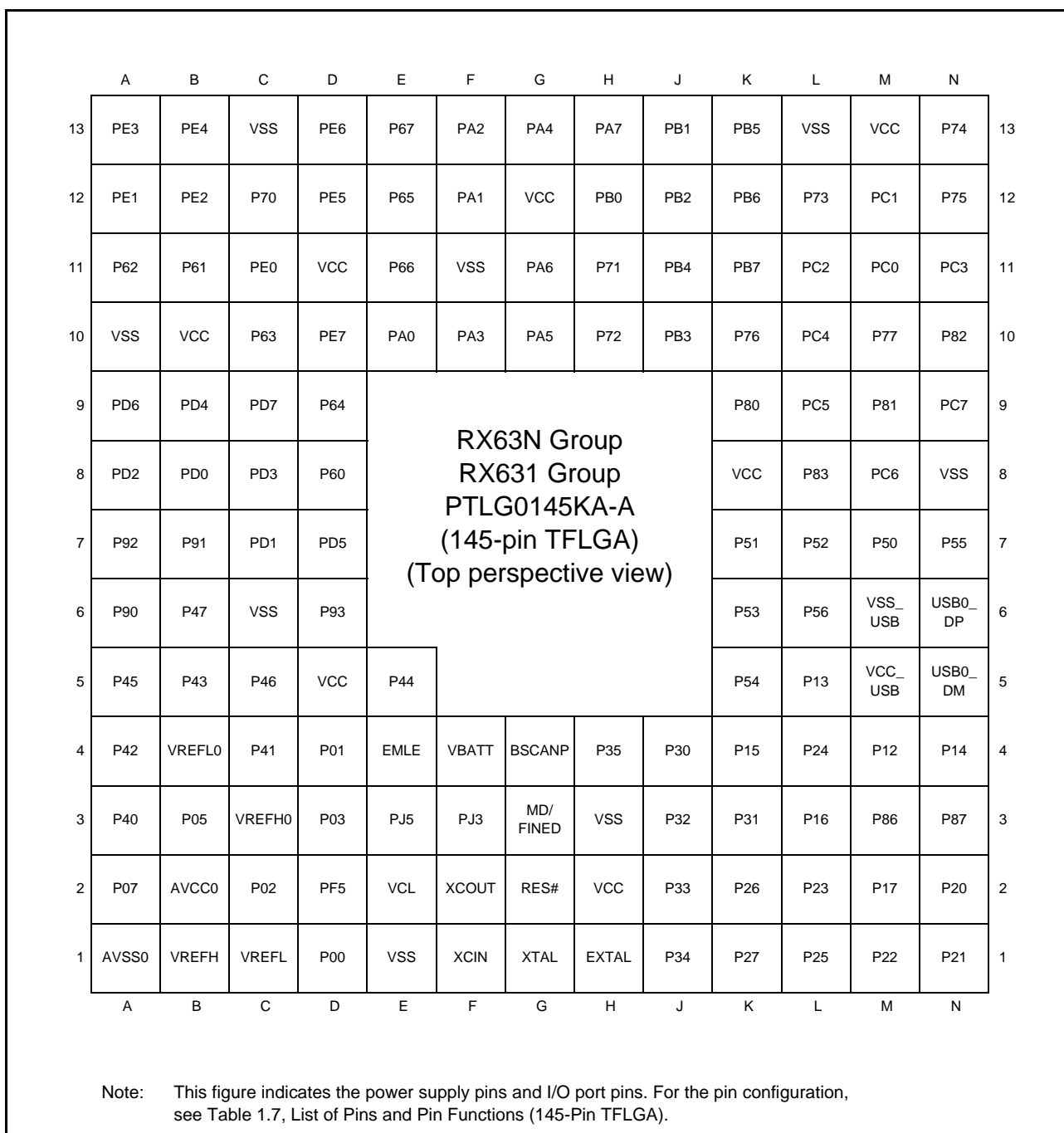


Figure 1.6 Pin Assignment (145-Pin TFLGA)

Note 3. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA) (3/5)

Pin No. 145-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SClc, SClD, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
H12		PB0	A8	MTIOC5W/TIOCA3/PO24	RXD4/RXD6/SMISO4/ SMISO6/SSCL4/SSCL6/ RSPCKA/T_ERXD1/ RMII_RXD1	IRQ12	
H13		PA7	A7	TIOCB2/PO23	MISOA/ET_WOL		
J1	TRST#	P34		MTIOC0A/TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
J2		P33		MTIOC0D/TIOCD0/ TMR13/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/SSCL0/ CRX0/PCKO	IRQ3-DS	
J3		P32		MTIOC0C/TIOCC0/ TMO3/PO10/RTCOU/ RTCIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/SSDA0/ CTX0/USB0_VBUSEN/ VSYNC	IRQ2-DS	
J4	TDI	P30		MTIOC4B/TMR13/PO8/ RTCIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
J10		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK4/SCK6/ET_RX_ER/ RMII_RX_ER		
J11		PB4	A12	TIOCA4/PO28	CTS9#/RTS9#/SS9#/ ET_TX_EN/RMII_TXD_EN		
J12		PB2	A10	TIOCC3/TCLKC/PO26	CTS4#/RTS4#/CTS6#/ RTS6#/SS4#/SS6#/ ET_RX_CLK/REF50CK		
J13		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/SSDA6/ ET_ERXD0/RMII_RXD0	IRQ4-DS	
K1	TCK/FINEC	P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		
K2	TDO	P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3#/ SMOSI1/SS3#/SSDA1/ MOSIB		
K3	TMS	P31		MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
K4		P15		MTIOC0B/MTCLKB/ TIOCB2/TCLKB/TMCI2/ PO13	RXD1/SCK3/SMISO1/ SSCL1/CRX1-DS/PIXD0	IRQ5	
K5	TRDATA2	P54	ALE/EDACK0	MTIOC4B/TMCI1	CTS2#/RTS2#/SS2#/ CTX1/ET_LINKSTA		
K6		P53*1	BCLK				
K7		P51	WR1#/BC1#/ WAIT#		SCK2/SSLB2		
K8	VCC						
K9	TRDATA0	P80	EDREQ0	MTIOC3B/PO26	SCK10/ET_TX_EN/ RMII_TXD_EN		
K10		P76	CS6#	PO22	RXD11/SMISO11/SSCL11/ ET_RX_CLK/REF50CK		
K11		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/SMOSI9/SSDA9/ ET_CRS/RMII_CRS_DV		
K12		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/SMISO9/SSCL9/ ET_ETXD1/RMII_TXD1		
K13		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMR11/PO29/ POE1#	SCK9/ET_ETXD0/ RMII_TXD0		
L1		P25	CS5#/EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3/ USB0_DPRPD/HSYCN		ADTRG0#
L2		P23	EDACK0	MTIOC3D/MTCLKD/ TIOCD3/PO3	TXD3/CTS0#/RTS0#/ SMOSI3/SS0#/SSDA3/ USB0_DPUPE/PIXD7		

2.1 General-Purpose Registers (R0 to R15)

This CPU has sixteen general-purpose registers (R0 to R15). R1 to R15 can be used as data registers or address registers. R0, a general-purpose register, also functions as the stack pointer (SP).

The stack pointer is switched to operate as the interrupt stack pointer (ISP) or user stack pointer (USP) by the value of the stack pointer select bit (U) in the processor status word (PSW).

2.2 Control Registers

(1) Interrupt Stack Pointer (ISP)/User Stack Pointer (USP)

The stack pointer (SP) can be either of two types, the interrupt stack pointer (ISP) or the user stack pointer (USP). Whether the stack pointer operates as the ISP or USP depends on the value of the stack pointer select bit (U) in the processor status word (PSW).

Set the ISP or USP to a multiple of four, as this reduces the numbers of cycles required to execute interrupt sequences and instructions entailing stack manipulation.

(2) Interrupt Table Register (INTB)

The interrupt table register (INTB) specifies the address where the relocatable vector table starts.

(3) Program Counter (PC)

The program counter (PC) indicates the address of the instruction being executed.

(4) Processor Status Word (PSW)

The processor status word (PSW) indicates the results of instruction execution or the state of the CPU.

(5) Backup PC (BPC)

The backup PC (BPC) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the program counter (PC) are saved in the BPC register.

(6) Backup PSW (BPSW)

The backup PSW (BPSW) is provided to speed up response to interrupts.

After a fast interrupt has been generated, the contents of the processor status word (PSW) are saved in the BPSW. The allocation of bits in the BPSW corresponds to that in the PSW.

(7) Fast Interrupt Vector Register (FINTV)

The fast interrupt vector register (FINTV) is provided to speed up response to interrupts.

The FINTV register specifies a branch destination address when a fast interrupt has been generated.

(8) Floating-Point Status Word (FPSW)

The floating-point status word (FPSW) indicates the results of floating-point operations.

When an exception handling enable bit (Ej) enables the exception handling (Ej = 1), the exception cause can be identified by checking the corresponding Cj flag in the exception handling routine. If the exception handling is masked (Ej = 0), the occurrence of exception can be checked by reading the Fj flag at the end of a series of processing. Once the Fj flag has been set to 1, this value is retained until it is cleared to 0 by software (j = X, U, Z, O, or V).

2.3 Register Associated with DSP Instructions

(1) Accumulator (ACC)

The accumulator (ACC) is a 64-bit register used for DSP instructions. The accumulator is also used for the multiply and multiply-and-accumulate instructions; EMUL, EMULU, FMUL, MUL, and RMPA, in which case the prior value in the accumulator is modified by execution of the instruction.

Use the MVTACHI and MVTACLO instructions for writing to the accumulator. The MVTACHI and MVTACLO instructions write data to the higher-order 32 bits (bits 63 to 32) and the lower-order 32 bits (bits 31 to 0), respectively. Use the MVFACHI and MVFACMI instructions for reading data from the accumulator. The MVFACHI and MVFACMI instructions read data from the higher-order 32 bits (bits 63 to 32) and the middle 32 bits (bits 47 to 16), respectively.

Table 4.1 List of I/O Registers (Address Order) (10/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 719Ch	ICU	DTC activation enable register 156	DTCER156	8	8	2	ICLK	ICUb
0008 719Dh	ICU	DTC activation enable register 157	DTCER157	8	8	2	ICLK	
0008 719Eh	ICU	DTC activation enable register 158	DTCER158	8	8	2	ICLK	
0008 719Fh	ICU	DTC activation enable register 159	DTCER159	8	8	2	ICLK	
0008 71A0h	ICU	DTC activation enable register 160	DTCER160	8	8	2	ICLK	
0008 71A1h	ICU	DTC activation enable register 161	DTCER161	8	8	2	ICLK	
0008 71A2h	ICU	DTC activation enable register 162	DTCER162	8	8	2	ICLK	
0008 71A3h	ICU	DTC activation enable register 163	DTCER163	8	8	2	ICLK	
0008 71A4h	ICU	DTC activation enable register 164	DTCER164	8	8	2	ICLK	
0008 71A5h	ICU	DTC activation enable register 165	DTCER165	8	8	2	ICLK	
0008 71AAh	ICU	DTC activation enable register 170	DTCER170	8	8	2	ICLK	
0008 71ABh	ICU	DTC activation enable register 171	DTCER171	8	8	2	ICLK	
0008 71ADh	ICU	DTC activation enable register 173	DTCER173	8	8	2	ICLK	
0008 71AEh	ICU	DTC activation enable register 174	DTCER174	8	8	2	ICLK	
0008 71B0h	ICU	DTC activation enable register 176	DTCER176	8	8	2	ICLK	
0008 71B1h	ICU	DTC activation enable register 177	DTCER177	8	8	2	ICLK	
0008 71B3h	ICU	DTC activation enable register 179	DTCER179	8	8	2	ICLK	
0008 71B4h	ICU	DTC activation enable register 180	DTCER180	8	8	2	ICLK	
0008 71B7h	ICU	DTC activation enable register 183	DTCER183	8	8	2	ICLK	
0008 71B8h	ICU	DTC activation enable register 184	DTCER184	8	8	2	ICLK	
0008 71BBh	ICU	DTC activation enable register 187	DTCER187	8	8	2	ICLK	
0008 71BCh	ICU	DTC activation enable register 188	DTCER188	8	8	2	ICLK	
0008 71BFh	ICU	DTC activation enable register 191	DTCER191	8	8	2	ICLK	
0008 71C0h	ICU	DTC activation enable register 192	DTCER192	8	8	2	ICLK	
0008 71C3h	ICU	DTC activation enable register 195	DTCER195	8	8	2	ICLK	
0008 71C4h	ICU	DTC activation enable register 196	DTCER196	8	8	2	ICLK	
0008 71C6h	ICU	DTC activation enable register 198	DTCER198	8	8	2	ICLK	
0008 71C7h	ICU	DTC activation enable register 199	DTCER199	8	8	2	ICLK	
0008 71C8h	ICU	DTC activation enable register 200	DTCER200	8	8	2	ICLK	
0008 71C9h	ICU	DTC activation enable register 201	DTCER201	8	8	2	ICLK	
0008 71CAh	ICU	DTC activation enable register 202	DTCER202	8	8	2	ICLK	
0008 71CBh	ICU	DTC activation enable register 203	DTCER203	8	8	2	ICLK	
0008 71CEh	ICU	DTC activation enable register 206	DTCER206	8	8	2	ICLK	
0008 71CFh	ICU	DTC activation enable register 207	DTCER207	8	8	2	ICLK	
0008 71D0h	ICU	DTC activation enable register 208	DTCER208	8	8	2	ICLK	
0008 71D6h	ICU	DTC activation enable register 214	DTCER214	8	8	2	ICLK	
0008 71D7h	ICU	DTC activation enable register 215	DTCER215	8	8	2	ICLK	
0008 71D9h	ICU	DTC activation enable register 217	DTCER217	8	8	2	ICLK	
0008 71DAh	ICU	DTC activation enable register 218	DTCER218	8	8	2	ICLK	
0008 71DCh	ICU	DTC activation enable register 220	DTCER220	8	8	2	ICLK	
0008 71DDh	ICU	DTC activation enable register 221	DTCER221	8	8	2	ICLK	
0008 71DFh	ICU	DTC activation enable register 223	DTCER223	8	8	2	ICLK	
0008 71E0h	ICU	DTC activation enable register 224	DTCER224	8	8	2	ICLK	
0008 71E2h	ICU	DTC activation enable register 226	DTCER226	8	8	2	ICLK	
0008 71E3h	ICU	DTC activation enable register 227	DTCER227	8	8	2	ICLK	
0008 71E5h	ICU	DTC activation enable register 229	DTCER229	8	8	2	ICLK	
0008 71E6h	ICU	DTC activation enable register 230	DTCER230	8	8	2	ICLK	
0008 71E8h	ICU	DTC activation enable register 232	DTCER232	8	8	2	ICLK	
0008 71E9h	ICU	DTC activation enable register 233	DTCER233	8	8	2	ICLK	
0008 71EBh	ICU	DTC activation enable register 235	DTCER235	8	8	2	ICLK	
0008 71ECh	ICU	DTC activation enable register 236	DTCER236	8	8	2	ICLK	

Table 4.1 List of I/O Registers (Address Order) (23/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK _≥ PCLK	ICLK _{<} PCLK	
0008 8800h	MTU2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	MTU2a
0008 8801h	MTU2	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8802h	MTU2	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 8804h	MTU2	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8805h	MTU2	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8806h	MTU2	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8808h	MTU2	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 880Ah	MTU2	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8880h	MTU5	Timer counter U	TCNTU	16	16	2, 3 PCLKB	2 ICLK	
0008 8882h	MTU5	Timer general register U	TGRU	16	16	2, 3 PCLKB	2 ICLK	
0008 8884h	MTU5	Timer control register U	TCRU	8	8	2, 3 PCLKB	2 ICLK	
0008 8886h	MTU5	Timer I/O control register U	TIORU	8	8	2, 3 PCLKB	2 ICLK	
0008 8890h	MTU5	Timer counter V	TCNTV	16	16	2, 3 PCLKB	2 ICLK	
0008 8892h	MTU5	Timer general register V	TGRV	16	16	2, 3 PCLKB	2 ICLK	
0008 8894h	MTU5	Timer control register V	TCRV	8	8	2, 3 PCLKB	2 ICLK	
0008 8896h	MTU5	Timer I/O control register V	TIORV	8	8	2, 3 PCLKB	2 ICLK	
0008 88A0h	MTU5	Timer counter W	TCNTW	16	16	2, 3 PCLKB	2 ICLK	
0008 88A2h	MTU5	Timer general register W	TGRW	16	16	2, 3 PCLKB	2 ICLK	
0008 88A4h	MTU5	Timer control register W	TCRW	8	8	2, 3 PCLKB	2 ICLK	
0008 88A6h	MTU5	Timer I/O control register W	TIORW	8	8	2, 3 PCLKB	2 ICLK	
0008 88B2h	MTU5	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 88B4h	MTU5	Timer start register	TSTR	8	8	2, 3 PCLKB	2 ICLK	
0008 88B6h	MTU5	Timer compare match clear register	TCNTCMPCLR	8	8	2, 3 PCLKB	2 ICLK	
0008 8900h	POE	Input level control/status register 1	ICSR1	16	16	2, 3 PCLKB	2 ICLK	POE2a
0008 8902h	POE	Output level control/status register 1	OCSR1	16	16	2, 3 PCLKB	2 ICLK	
0008 8908h	POE	Input level control/status register 2	ICSR2	16	16	2, 3 PCLKB	2 ICLK	
0008 890Ah	POE	Software port output enable register	SPOER	8	8	2, 3 PCLKB	2 ICLK	
0008 890Bh	POE	Port output enable control register 1	POECR1	8	8	2, 3 PCLKB	2 ICLK	
0008 890Ch	POE	Port output enable control register 2	POECR2	8	8	2, 3 PCLKB	2 ICLK	
0008 890Eh	POE	Input level control/status register 3	ICSR3	16	16	2, 3 PCLKB	2 ICLK	
0008 9000h	S12AD	A/D control register	ADCSR	8	8	2, 3 PCLKB	2 ICLK	S12ADa
0008 9004h	S12AD	A/D channel select register 0	ADANS0	16	16	2, 3 PCLKB	2 ICLK	
0008 9006h	S12AD	A/D channel select register 1	ADANS1	16	16	2, 3 PCLKB	2 ICLK	
0008 9008h	S12AD	A/D-converted value addition mode select register 0	ADADS0	16	16	2, 3 PCLKB	2 ICLK	
0008 900Ah	S12AD	A/D-converted value addition mode select register 1	ADADS1	16	16	2, 3 PCLKB	2 ICLK	
0008 900Ch	S12AD	A/D-converted value addition count select register	ADADC	8	8	2, 3 PCLKB	2 ICLK	
0008 900Eh	S12AD	A/D control extended register	ADCER	16	16	2, 3 PCLKB	2 ICLK	
0008 9010h	S12AD	A/D start trigger select register	ADSTRGR	8	8	2, 3 PCLKB	2 ICLK	
0008 9012h	S12AD	A/D conversion extended input control register	ADEXICR	16	16	2, 3 PCLKB	2 ICLK	
0008 901Ah	S12AD	A/D temperature sensor data register	ADTSDR	16	16	2, 3 PCLKB	2 ICLK	
0008 901Ch	S12AD	A/D internal reference voltage data register	ADOCDR	16	16	2, 3 PCLKB	2 ICLK	
0008 9020h	S12AD	A/D data register 0	ADDR0	16	16	2, 3 PCLKB	2 ICLK	
0008 9022h	S12AD	A/D data register 1	ADDR1	16	16	2, 3 PCLKB	2 ICLK	
0008 9024h	S12AD	A/D data register 2	ADDR2	16	16	2, 3 PCLKB	2 ICLK	
0008 9026h	S12AD	A/D data register 3	ADDR3	16	16	2, 3 PCLKB	2 ICLK	
0008 9028h	S12AD	A/D data register 4	ADDR4	16	16	2, 3 PCLKB	2 ICLK	
0008 902Ah	S12AD	A/D data register 5	ADDR5	16	16	2, 3 PCLKB	2 ICLK	
0008 902Ch	S12AD	A/D data register 6	ADDR6	16	16	2, 3 PCLKB	2 ICLK	
0008 902Eh	S12AD	A/D data register 7	ADDR7	16	16	2, 3 PCLKB	2 ICLK	
0008 9030h	S12AD	A/D data register 8	ADDR8	16	16	2, 3 PCLKB	2 ICLK	
0008 9032h	S12AD	A/D data register 9	ADDR9	16	16	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (35/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK \geq PCLK	ICLK<PCLK	
0008 C344h	ICU	Group 1 interrupt enable register	GEN01	32	32	1 to 2PCLKB	2 ICLK	ICUb
0008 C348h	ICU	Group 2 interrupt enable register	GEN02	32	32	1 to 2PCLKB	2 ICLK	
0008 C34Ch	ICU	Group 3 interrupt enable register	GEN03	32	32	1 to 2PCLKB	2 ICLK	
0008 C350h	ICU	Group 4 interrupt enable register	GEN04	32	32	1 to 2PCLKB	2 ICLK	
0008 C354h	ICU	Group 5 interrupt enable register	GEN05	32	32	1 to 2PCLKB	2 ICLK	
0008 C358h	ICU	Group 6 interrupt enable register	GEN06	32	32	1 to 2PCLKB	2 ICLK	
0008 C370h	ICU	Group 12 interrupt enable register	GEN12	32	32	1 to 2PCLKB	2 ICLK	
0008 C380h	ICU	Group 0 interrupt clear register	GCR00	32	32	1 to 2PCLKB	2 ICLK	
0008 C384h	ICU	Group 1 interrupt clear register	GCR01	32	32	1 to 2PCLKB	2 ICLK	
0008 C388h	ICU	Group 2 interrupt clear register	GCR02	32	32	1 to 2PCLKB	2 ICLK	
0008 C38Ch	ICU	Group 3 interrupt clear register	GCR03	32	32	1 to 2PCLKB	2 ICLK	
0008 C390h	ICU	Group 4 interrupt clear register	GCR04	32	32	1 to 2PCLKB	2 ICLK	
0008 C394h	ICU	Group 5 interrupt clear register	GCR05	32	32	1 to 2PCLKB	2 ICLK	
0008 C398h	ICU	Group 6 interrupt clear register	GCR06	32	32	1 to 2PCLKB	2 ICLK	
0008 C3C0h	ICU	Unit select register	SEL	32	32	1 to 2PCLKB	2 ICLK	
0008 C400h	RTC	64-Hz counter	R64CNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C402h	RTC	Second counter	RSECCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C404h	RTC	Minute counter	RMINCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C406h	RTC	Hour counter	RHRCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C408h	RTC	Day-of-week counter	RWKCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Ah	RTC	Date counter	RDAYCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Ch	RTC	Month counter	RMONCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Eh	RTC	Year counter	RYRCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 C410h	RTC	Second alarm register	RSECAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C412h	RTC	Minute alarm register	RMINAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C414h	RTC	Hour alarm register	RHRAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C416h	RTC	Day-of-week alarm register	RWKAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C418h	RTC	Date alarm register	RDAYAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C41Ah	RTC	Month alarm register	RMONAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C41Ch	RTC	Year alarm register	RYRAR	16	16	2, 3 PCLKB	2 ICLK	
0008 C41Eh	RTC	Year alarm enable register	RYRAREN	8	8	2, 3 PCLKB	2 ICLK	
0008 C422h	RTC	RTC control register 1	RCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 C424h	RTC	RTC control register 2	RCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 C426h	RTC	RTC control register 3	RCR3	8	8	2, 3 PCLKB	2 ICLK	
0008 C428h	RTC	RTC control register 4	RCR4	8	8	2, 3 PCLKB	2 ICLK	
0008 C42Ah	RTC	Frequency register H	RFRH	16	16	2, 3 PCLKB	2 ICLK	
0008 C42Ch	RTC	Frequency register L	RFRL	16	16	2, 3 PCLKB	2 ICLK	
0008 C42Eh	RTC	Time error adjustment register	RADJ	8	8	2, 3 PCLKB	2 ICLK	
0008 C440h	RTC	Time capture control register 0	RTCCR0	8	8	2, 3 PCLKB	2 ICLK	
0008 C442h	RTC	Time capture control register 1	RTCCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 C444h	RTC	Time capture control register 2	RTCCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 C452h	RTC	Second capture register 0	RSECCP0	8	8	2, 3 PCLKB	2 ICLK	
0008 C454h	RTC	Minute capture register 0	RMINCP0	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (36/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK \geq PCLK	ICLK<PCLK	
0008 C456h	RTC	Hour capture register 0	RHRCP0	8	8	2, 3 PCLKB	2 ICLK	RTCa
0008 C45Ah	RTC	Date capture register 0	RDAYCP0	8	8	2, 3 PCLKB	2 ICLK	
0008 C45Ch	RTC	Month capture register 0	RMONCP0	8	8	2, 3 PCLKB	2 ICLK	
0008 C462h	RTC	Second capture register 1	RSECCP1	8	8	2, 3 PCLKB	2 ICLK	
0008 C464h	RTC	Minute capture register 1	RMINCP1	8	8	2, 3 PCLKB	2 ICLK	
0008 C466h	RTC	Hour capture register 1	RHRCP1	8	8	2, 3 PCLKB	2 ICLK	
0008 C46Ah	RTC	Date capture register 1	RDAYCP1	8	8	2, 3 PCLKB	2 ICLK	
0008 C46Ch	RTC	Month capture register 1	RMONCP1	8	8	2, 3 PCLKB	2 ICLK	
0008 C472h	RTC	Second capture register 2	RSECCP2	8	8	2, 3 PCLKB	2 ICLK	
0008 C474h	RTC	Minute capture register 2	RMINCP2	8	8	2, 3 PCLKB	2 ICLK	
0008 C476h	RTC	Hour capture register 2	RHRCP2	8	8	2, 3 PCLKB	2 ICLK	
0008 C47Ah	RTC	Date capture register 2	RDAYCP2	8	8	2, 3 PCLKB	2 ICLK	
0008 C47Ch	RTC	Month capture register 2	RMONCP2	8	8	2, 3 PCLKB	2 ICLK	
0008 C500h	TEMPS	Temperature sensor control register	TSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C880h	SYSTEM	Counter-clock extension register 1	SCK1	8	8	2, 3 PCLKB	2 ICLK	MCK
0008 C890h	SYSTEM	Counter-clock extension register 2	SCK2	8	8	2, 3 PCLKB	2 ICLK	
0009 0200h to 0009 03FFh	CAN0	Mailbox registers 0 to 31	MB0 to 31	128	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 0400h to 0009 041Fh	CAN0	Mask register 0 to 7	MKR0 to 7	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 0420h	CAN0	FIFO received ID compare register 0	FIDCR0	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 0424h	CAN0	FIFO received ID compare register 1	FIDCR1	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 0428h	CAN0	Mask invalid register	MKIVLR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 042Ch	CAN0	Mailbox interrupt enable register	MIER	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 0820h to 0009 083Fh	CAN0	Message control registers 0 to 31	MCTL0 to 31	8	8	2, 3 PCLKB	2 ICLK	
0009 0840h	CAN0	Control register	CTLR	16	8, 16	2, 3 PCLKB	2 ICLK	
0009 0842h	CAN0	Status register	STR	16	8, 16	2, 3 PCLKB	2 ICLK	
0009 0844h	CAN0	Bit configuration register	BCR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 0848h	CAN0	Receive FIFO control register	RFCR	8	8	2, 3 PCLKB	2 ICLK	
0009 0849h	CAN0	Receive FIFO pointer control register	RFPCR	8	8	2, 3 PCLKB	2 ICLK	
0009 084Ah	CAN0	Transmit FIFO control register	TFCR	8	8	2, 3 PCLKB	2 ICLK	
0009 084Bh	CAN0	Transmit FIFO pointer control register	TFPCR	8	8	2, 3 PCLKB	2 ICLK	
0009 084Ch	CAN0	Error interrupt enable register	EIER	8	8	2, 3 PCLKB	2 ICLK	
0009 084Dh	CAN0	Error interrupt factor judge register	EIFR	8	8	2, 3 PCLKB	2 ICLK	
0009 084Eh	CAN0	Receive error count register	RECR	8	8	2, 3 PCLKB	2 ICLK	
0009 084Fh	CAN0	Transmit error count register	TECR	8	8	2, 3 PCLKB	2 ICLK	
0009 0850h	CAN0	Error code store register	ECSR	8	8	2, 3 PCLKB	2 ICLK	
0009 0851h	CAN0	Channel search support register	CSSR	8	8	2, 3 PCLKB	2 ICLK	
0009 0852h	CAN0	Mailbox search status register	MSSR	8	8	2, 3 PCLKB	2 ICLK	
0009 0853h	CAN0	Mailbox search mode register	MSMR	8	8	2, 3 PCLKB	2 ICLK	
0009 0854h	CAN0	Time stamp register	TSR	16	16	2, 3 PCLKB	2 ICLK	
0009 0856h	CAN0	Acceptance filter support register	AFSR	16	16	2, 3 PCLKB	2 ICLK	
0009 0858h	CAN0	Test control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0009 1200h to 0009 13FFh	CAN1	Mailbox registers 0 to 31	MB0 to 31	128	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 1400h to 0009 141Fh	CAN1	Mask register 0 to 7	MKR0 to 7	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 1420h	CAN1	FIFO received ID compare register 0	FIDCR0	32	8, 16, 32	2, 3 PCLKB	2 ICLK	
0009 1424h	CAN1	FIFO received ID compare register 1	FIDCR1	32	8, 16, 32	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (39/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK \geq PCLK	ICLK<PCLK	
000A 003Ah	USB0	BEMP interrupt enable register	BEMPENB	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	USBa
000A 003Ch	USB0	SOF output configuration register	SOFCFG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0040h	USB0	Interrupt status register 0	INTSTS0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0042h	USB0	Interrupt status register 1	INTSTS1	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0046h	USB0	BRDY interrupt status register	BRDYSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0048h	USB0	NRDY interrupt status register	NRDYSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 004Ah	USB0	BEMP interrupt status register	BEMPSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 004Ch	USB0	Frame number register	FRMNUM	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 004Eh	USB0	Device state changing register	DVCHGR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	USBa
000A 0050h	USB0	USB address register	USBADDR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	

Table 4.1 List of I/O Registers (Address Order) (50/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK \geq PCLK	ICLK<PCLK	
007F C402h	FLASH	Flash mode register	FMODR	8	8	2 to 4 FCLK	2, 3 ICLK	Flash Memory
007F C410h	FLASH	Flash access status register	FASTAT	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C411h	FLASH	Flash access error interrupt enable register	FAEINT	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C412h	FLASH	Flash ready interrupt enable register	FRDYIE	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C440h	FLASH	E2 DataFlash read enable register 0	DFLRE0	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C442h	FLASH	E2 DataFlash read enable register 1	DFLRE1	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C450h	FLASH	E2 DataFlash P/E enable register 0	DFLWE0	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C452h	FLASH	E2 DataFlash P/E enable register 1	DFLWE1	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C454h	FLASH	FCU RAM enable register	FCURAME	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB0h	FLASH	Flash status register 0	FSTATR0	8	8	2 to 4 FCLK	2, 3 ICLK	
007F FFB1h	FLASH	Flash status register 1	FSTATR1	8	8	2 to 4 FCLK	2, 3 ICLK	
007F FFB2h	FLASH	Flash P/E mode entry register	FENTRYR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB4h	FLASH	Flash protection register	FPROTR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB6h	FLASH	Flash reset register	FRESETR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFBAh	FLASH	FCU command register	FCMDR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFC8h	FLASH	FCU processing switching register	FCPSR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCAh	FLASH	E2 data flash blank check control register	DFLBCCNT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCCh	FLASH	Flash P/E status register	FPESTAT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCEh	FLASH	E2 DataFlash blank check status register	DFLBCSTAT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFE8h	FLASH	Peripheral clock notification register	PCKAR	16	16	2 to 4 FCLK	2, 3 ICLK	
FEFF FAC0h	FLASH	Unique ID register 0* ⁸	UIDR0	8	8	1 ICLK	1 ICLK	
FEFF FAC1h	FLASH	Unique ID register 1* ⁸	UIDR1	8	8	1 ICLK	1 ICLK	
FEFF FAC2h	FLASH	Unique ID register 2* ⁸	UIDR2	8	8	1 ICLK	1 ICLK	
FEFF FAC3h	FLASH	Unique ID register 3* ⁸	UIDR3	8	8	1 ICLK	1 ICLK	
FEFF FAC4h	FLASH	Unique ID register 4* ⁸	UIDR4	8	8	1 ICLK	1 ICLK	
FEFF FAC5h	FLASH	Unique ID register 5* ⁸	UIDR5	8	8	1 ICLK	1 ICLK	
FEFF FAC6h	FLASH	Unique ID register 6* ⁸	UIDR6	8	8	1 ICLK	1 ICLK	
FEFF FAC7h	FLASH	Unique ID register 7* ⁸	UIDR7	8	8	1 ICLK	1 ICLK	
FEFF FAC8h	FLASH	Unique ID register 8* ⁸	UIDR8	8	8	1 ICLK	1 ICLK	
FEFF FAC9h	FLASH	Unique ID register 9* ⁸	UIDR9	8	8	1 ICLK	1 ICLK	
FEFF FACAh	FLASH	Unique ID register 10* ⁸	UIDR10	8	8	1 ICLK	1 ICLK	
FEFF FACBh	FLASH	Unique ID register 11* ⁸	UIDR11	8	8	1 ICLK	1 ICLK	
FEFF FACCh	FLASH	Unique ID register 12* ⁸	UIDR12	8	8	1 ICLK	1 ICLK	
FEFF FACDh	FLASH	Unique ID register 13* ⁸	UIDR13	8	8	1 ICLK	1 ICLK	
FEFF FACEh	FLASH	Unique ID register 14* ⁸	UIDR14	8	8	1 ICLK	1 ICLK	
FEFF FACFh	FLASH	Unique ID register 15* ⁸	UIDR15	8	8	1 ICLK	1 ICLK	
FEFF FAD2h	TEMPS	Temperature sensor calibration data register* ⁸	TSCDRL	8	8	1 ICLK	1 ICLK	Temperature sensor
FEFF FAD3h	TEMPS	Temperature sensor calibration data register* ⁸	TSCDRH	8	8	1 ICLK	1 ICLK	

- Note 1. When the same output trigger is specified for pulse output groups 2 and 3 by the PPG0.PCR setting, the PPG0.NDRH address is 000881ECh. When different output triggers are specified, the PPG0.NDRH addresses for pulse output groups 2 and 3 are 000881EEh and 000881ECh, respectively.
- Note 2. When the same output trigger is specified for pulse output groups 0 and 1 by the PPG0.PCR setting, the PPG0.NDRL address is 000881EDh. When different output triggers are specified, the PPG0.NDRL addresses for pulse output groups 0 and 1 are 000881EFh and 000881EDh, respectively.
- Note 3. When the same output trigger is specified for pulse output groups 6 and 7 by the PPG1.PCR setting, the PPG1.NDRH address is 000881FCh. When different output triggers are specified, the PPG1.NDRH addresses for pulse output groups 6 and 7 are 000881FEh and 000881FCh, respectively.
- Note 4. When the same output trigger is specified for pulse output groups 4 and 5 by the PPG1.PCR setting, the PPG1.NDRL address is 000881FDh. When different output triggers are specified, the PPG1.NDRL addresses for pulse output groups 4 and 5 are 000881FFh and 000881FDh, respectively.
- Note 5. Odd addresses should not be accessed in 16-bit units. When accessing a register in 16-bit units, access the address of the TMR0 or TMR2 register. Table 27.4 lists register allocation for 16-bit access in the User's manual: Hardware.
- Note 6. When the register is accessed while the USB is operating, a delay may be generated in accessing.
- Note 7. The addresses with odd number cannot be accessed in 16-bit units. 16-bit access to a register should be made to the addresses of the TMOCNL register. Allocation of registers to be accessed in 16-bit units is described in the Table 36.6, Allocation of Registers to be Accessed in 16-bit Units in the User's manual: Hardware.
- Note 8. These registers are only present in the G version.

Table 5.5 DC Characteristics (4) (for G Version (+85 < Ta ≤ +105°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = VBATT = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0, VSS = AVSS0 = VREFL/VREFLO = VSS_USB = 0 V, Ta = Topr

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Supply current*1	High-speed operating mode	Max.*2	—	—	115	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz	
		Normal*4	Peripheral function: clock signal supplied*4	—	52			—
			Peripheral function: clock signal stopped*4	—	40			—
		Sleep mode		—	25			80
		All-module-clock-stop mode (reference value)		—	20			53
		Increased by BGO operation*5		—	15			—
		Low-speed operating mode 1*6		—	4			—
	Low-speed operating mode 2		—	1	—	ICLK = 32.768 kHz		
	Software standby mode		—	0.2	9			
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit		—	22	200	µA	
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power consumption function disabled	—	21	60		
			Power-on reset circuit and low-power consumption function enabled	—	6.2	28		
		Increase when the RTC is operating	When a crystal oscillator for low clock loads is in use	—	1.0	—		
			When a crystal oscillator for standard clock loads is in use	—	3.0	—		
RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)		When a crystal oscillator for low clock loads is in use	—	0.9	—	VBATT = 2.0 V, VCC = 0V		
			—	1.6	—	VBATT = 3.3 V, VCC = 0V		
	When a crystal oscillator for standard clock loads is in use	—	1.7	—	VBATT = 2.0 V (for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V			
		—	3.3	—	VBATT = 3.3 V, VCC = 0V			
Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)		IAVCC0	—	2.3	3.2	mA	
	During 10-bit A/D conversion		IVREFH*9	—	1.0	1.65		
	During D/A conversion (per unit)			—	0.7	1.0		
	Waiting for A/D, D/A conversion (all units)*10		—	—	25	35		µA
	A/D, D/A converter in standby mode (all units)*10		—	—	0.1	5		µA
Reference power supply current	During 12-bit A/D conversion		IVREFH0	—	0.6	0.7	mA	
	Waiting for 12-bit A/D conversion (per unit)			—	0.5	0.6		
	12-bit A/D converter in standby mode (per unit)			—	0.1	2.0		µA
RAM standby voltage		V _{RAM}	2.7	—	—	V		
VCC rising gradient		SrVCC	8.4	—	20000	µs/V		
VCC falling gradient*8		SfVCC	8.4	—	—	µs/V		

- Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
- Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.
- Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK:PCLK:BCLK:BCLK pin = 8:4:4:2)
 I_{CC} Max. = $0.87 \times f + 13$ (max. operation in high-speed operating mode)
 I_{CC} Typ. = $0.35 \times f + 5$ (normal operation in high-speed operating mode)
 I_{CC} Typ. = $1.0 \times f + 3$ (low-speed operating mode 1)
 I_{CC} Max. = $0.53 \times f + 12$ (sleep mode)
- Note 4. This does not include the BGO operation.
- Note 5. This is the increase for programming or erasure of the ROM or flash memory for data storage during program execution.
- Note 6. Supply of the clock signal to peripherals is stopped in this state. This does not include the BGO operation.
- Note 7. The reference power supply current is included in the power supply current value for 10-bit A/D conversion and D/A conversion.
- Note 8. When V_{BATT} is used
- Note 9. The current values for 10-bit A/D converter and 10-bit D/A converter are included in the current from the VREFH pin.
- Note 10. The values are the sum of I_{AVCC0} and I_{VREFH} .

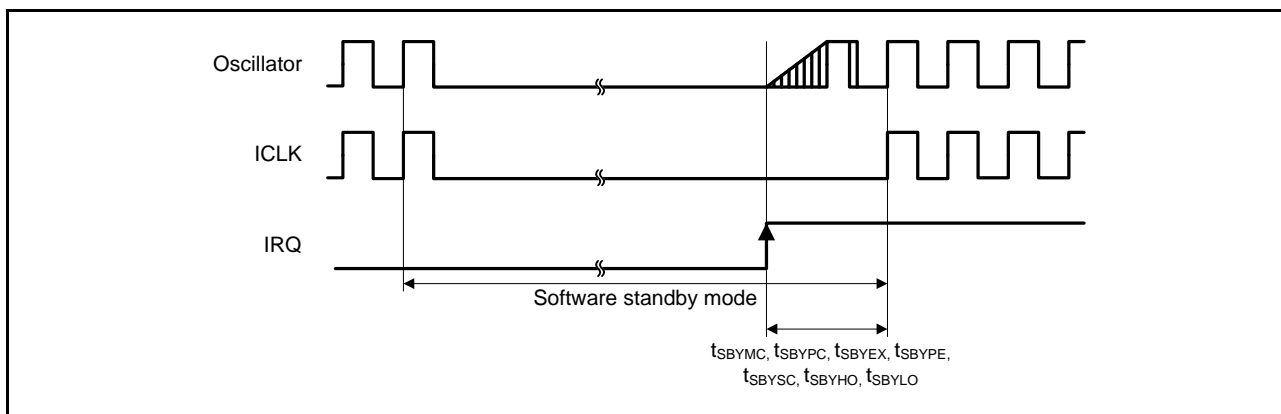


Figure 5.13 Software Standby Mode Cancellation Timing

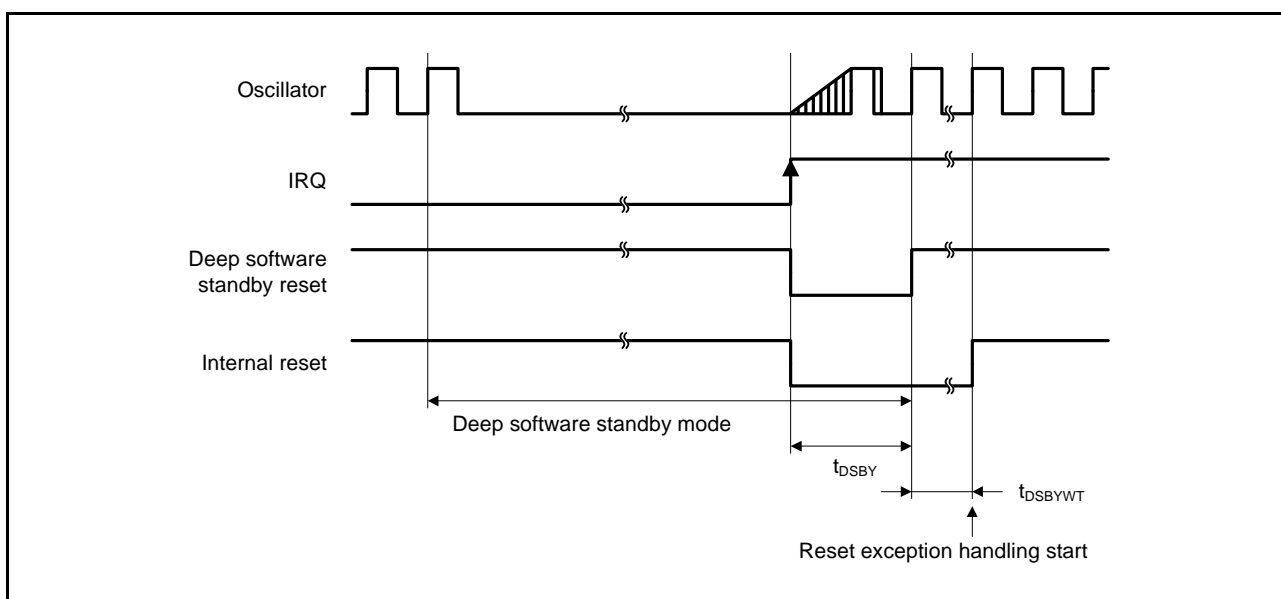


Figure 5.14 Deep Software Standby Mode Cancellation Timing

5.3.4 Control Signal Timing

Table 5.15 Control Signal Timing

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} ,
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
NMI pulse width	t_{NMIW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.15
		$t_c (PCLK) \times 2$	—	—		$t_c (PCLK) \times 2 > 200$ ns Figure 5.15
IRQ pulse width	t_{IRQW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.16
		$t_c (PCLK) \times 2$	—	—		$t_c (PCLK) \times 2 > 200$ ns Figure 5.16

Table 5.22 Timing of On-Chip Peripheral Modules (4)

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0}
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V
 $PCLK = 8$ to 50 MHz
 $T_a = T_{opr}$
 High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)	t_{SPcyc}	4	65536	t_{Pcyc}	Figure 5.42
	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width	t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time	t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time	t_{SU}	40	—	ns	Figure 5.43 to Figure 5.46
	Data input hold time	t_H	40	—	ns	
	SS input setup time	t_{LEAD}	1	—	t_{SPcyc}	
	SS input hold time	t_{LAG}	1	—	t_{SPcyc}	
	Data output delay time	t_{OD}	—	40	ns	
	Data output hold time	t_{OH}	-10	—	ns	
	Data rise/fall time	t_{Dr}, t_{Df}	—	20	ns	
	SS input rise/fall time	t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time	t_{SA}	—	5	t_{Pcyc}	Figure 5.46
	Slave output release time	t_{REL}	—	5	t_{Pcyc}	

Note 1. t_{Pcyc} : PCLK cycle

5.4 USB Characteristics

Table 5.27 On-Chip USB Full-Speed Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0
 VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
 PCLK = 24 to 50 MHz
 Ta = Topr
 High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions	
Input characteristics	Input high level voltage	V _{IH}	2.0	—	V		
	Input low level voltage	V _{IL}	—	0.8	V		
	Differential input sensitivity	V _{DI}	0.2	—	V	DP – DM	
	Differential common mode range	V _{CM}	0.8	2.5	V		
Output characteristics	Output high level voltage	V _{OH}	2.8	3.6	V	I _{OH} = -200 μA	
	Output low level voltage	V _{OL}	0.0	0.3	V	I _{OL} = 2 mA	
	Cross-over voltage	V _{CRS}	1.3	2.0	V		Figure 5.61
	Rise time	t _{Lr}	4	20	ns		
	Fall time	t _{Lf}	4	20	ns		
	Rise/fall time ratio	t _{Lr} / t _{Lf}	90	111.11	%	t _{Lr} / t _{Lf}	
	Output resistance	Z _{DRV}	28	44	Ω	Rs = 22 Ω included	

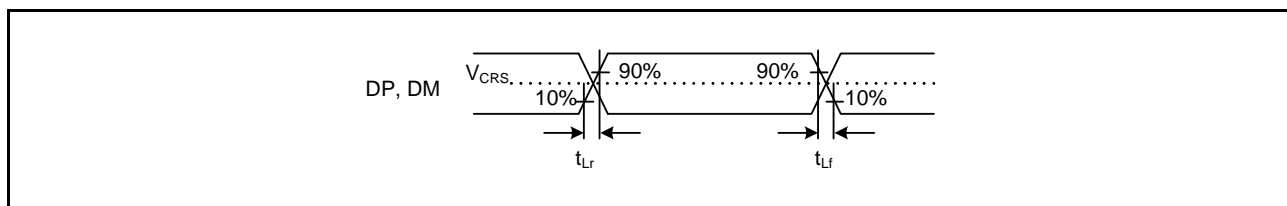


Figure 5.61 DP and DM Output Timing (Full-Speed)

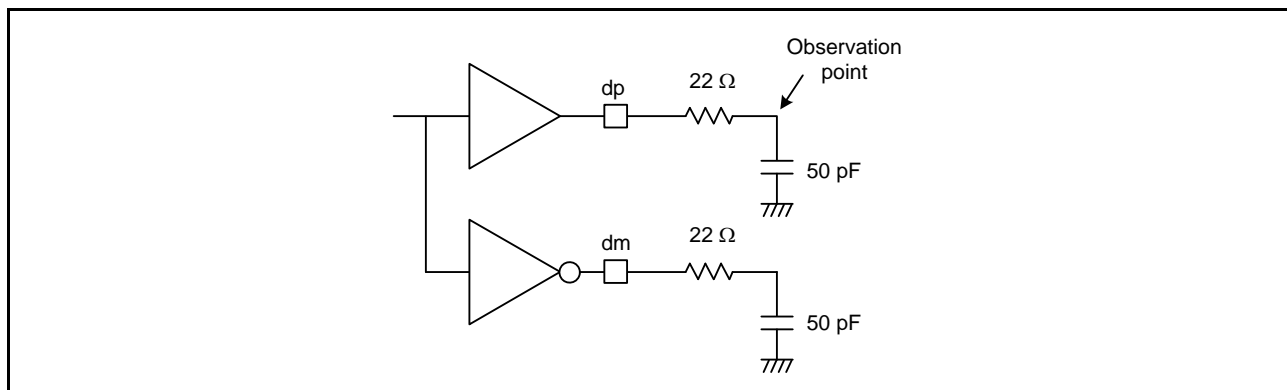


Figure 5.62 Test Circuit (Full-Speed)

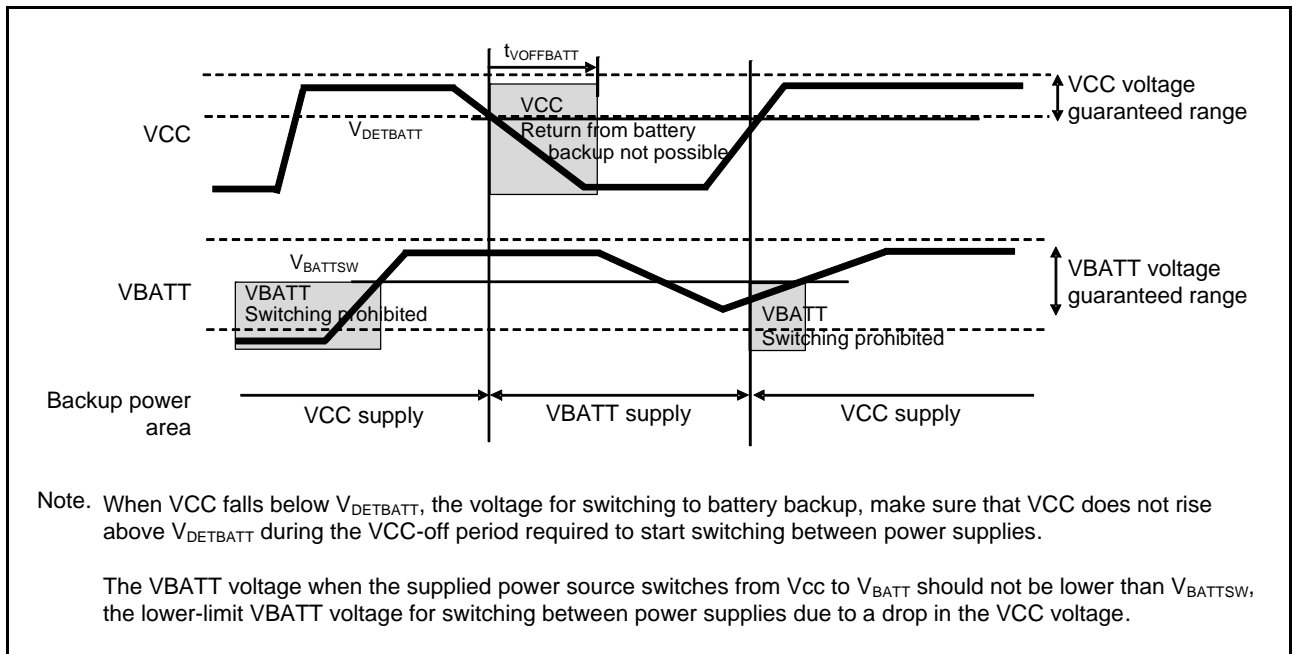
5.10 Battery Backup Function Characteristics

Table 5.35 Battery Backup Function Characteristics

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} , $V_{BATT} = 2.0$ to 3.6 V (for products with 100 pins or more), $V_{BATT} = 2.3$ to 3.6 V (for the 64-pin product)
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage level for switching to battery backup	$V_{DETBATT}$	2.50	2.60	2.70	V	Figure 5.68
Lower-limit V_{BATT} voltage for power supply switching due to VCC voltage drop	$V_{BATT_{SW}}$	2.70	—	—		
VCC-off period for starting power supply switching	$t_{V_{OFFBATT}}$	200	—	—		

Note: The VCC-off period for starting power supply switching indicates the period in which VCC is below the minimum value of the voltage level for switching to battery backup ($V_{DETBATT}$).



Note. When VCC falls below $V_{DETBATT}$, the voltage for switching to battery backup, make sure that VCC does not rise above $V_{DETBATT}$ during the VCC-off period required to start switching between power supplies.

The VBATT voltage when the supplied power source switches from Vcc to V_{BATT} should not be lower than $V_{BATT_{SW}}$, the lower-limit VBATT voltage for switching between power supplies due to a drop in the VCC voltage.

Figure 5.68 Battery Backup Function Characteristics

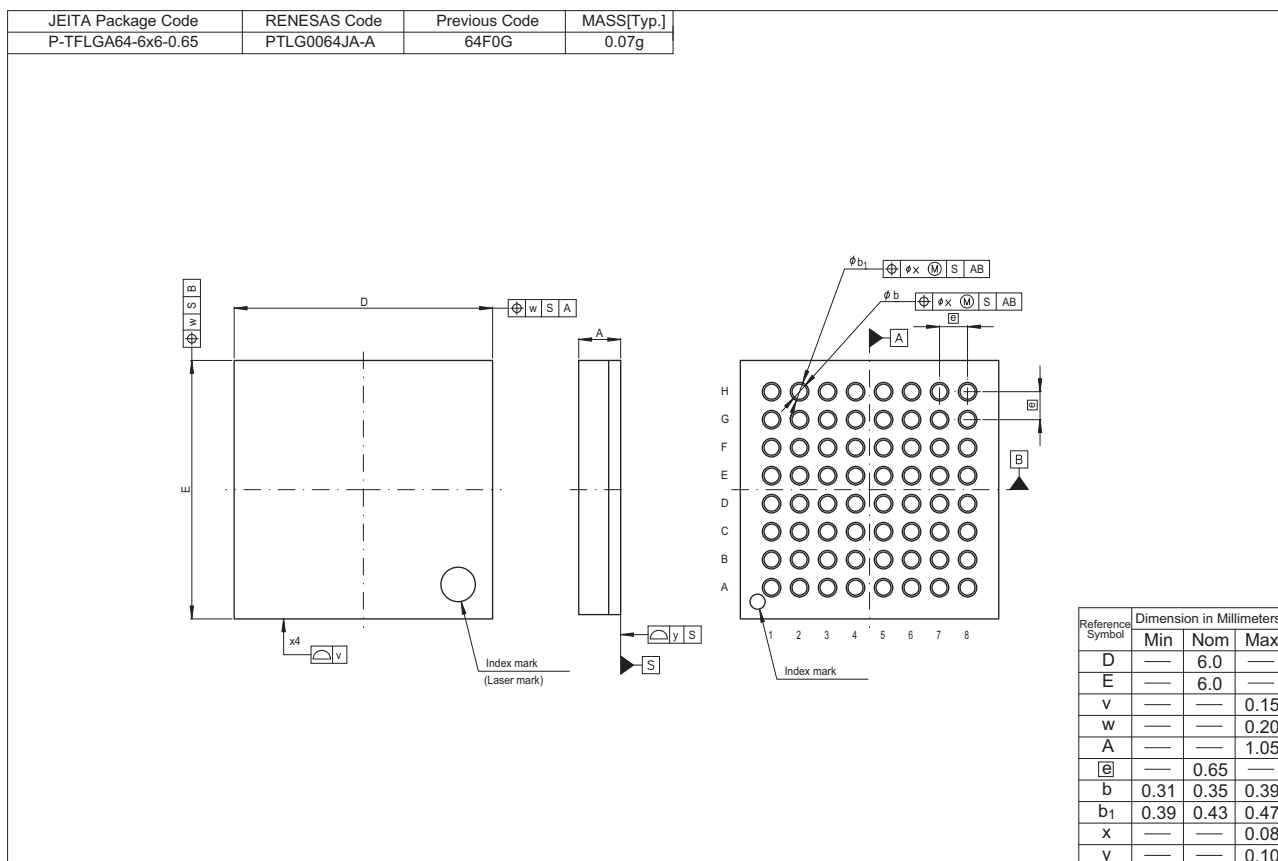


Figure H 64-pin TFLGA (PTLG0064JA-A)

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